



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# Ceramic Trimmer Capacitors



### **EU RoHS Compliant**

- All the products in this catalog comply with EU RoHS.
- EU RoHS is "the European Directive 2011/65/EU on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment."
- For more details, please refer to our website 'Murata's Approach for EU RoHS' (<http://www.murata.com/info/rohs.html>).

# CONTENTS

<b>Part Numbering</b>	2
<b>Selection Guide of Ceramic Trimmer Capacitors</b>	3
<b>1 TZR1 Series</b>	4
<b>2 TZS2 Series</b>	8
<b>3 TZY2 Series</b>	12
<b>4 TZV2 Series</b>	16
<b>5 TZC3 Series</b>	20
<b>6 TZW4 Series</b>	24
<b>7 TZB4 Series</b>	27
<b>8 TZ03 Series</b>	32
<b>Packaging</b>	37
<b>Recommended Adjustment Tools</b>	39
<b>Qualified Standards</b>	41

1

2

3

4

5

6

7

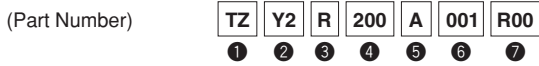
8

Bluetooth® is a registered trademark or trademark of Bluetooth SIG, Inc. in the United States and other countries.



● Part Numbering

Ceramic Trimmer Capacitors



① Product ID

Product ID	
TZ	Trimmer Capacitors

② Series/Terminal

Code	Series/Terminal
03	6mm Size Lead Type
B4	4mm Size SMD Type
W4	4mm Size SMD Type
C3	3mm Size SMD Type
S2	2mm Size SMD Type (Height 1.0mm)
Y2	2mm Size SMD Type (Height 1.25mm)
V2	2mm Size SMD Type (Height 1.45mm)
R1	1mm Size SMD Type (Height 0.90mm)

③ Temperature Characteristics

Code	Temperature Characteristics
Z	NP0ppm/°C
R	N750ppm/°C
K	N1000ppm/°C
P	N1200ppm/°C

Please refer to ratings for tolerance of temperature characteristics.

④ Maximum Capacitance

Expressed by three-digit alphanumerics. The unit is pico-farad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two numbers. If there is a decimal point, it is expressed by the capital letter "R". In this case, all figures are significant digits.

⑤ Terminal Shape

Code	Terminal Shape
A	Top Adjustment: <b>TZR1, TZS2, TZY2, TZV2, TZC3, TZW4, TZB4</b> (SMD Type)
B	Top Adjustment: <b>TZB4</b> (SMD Type)
E	Rear Adjustment: <b>TZB4</b> (SMD Type)
F	Top Adjustment: <b>TZ03</b> (Lead Type)
N	Rear Adjustment: <b>TZ03</b> (Lead Type)

Please refer to dimensions for terminal details.

⑥ Individual Specifications

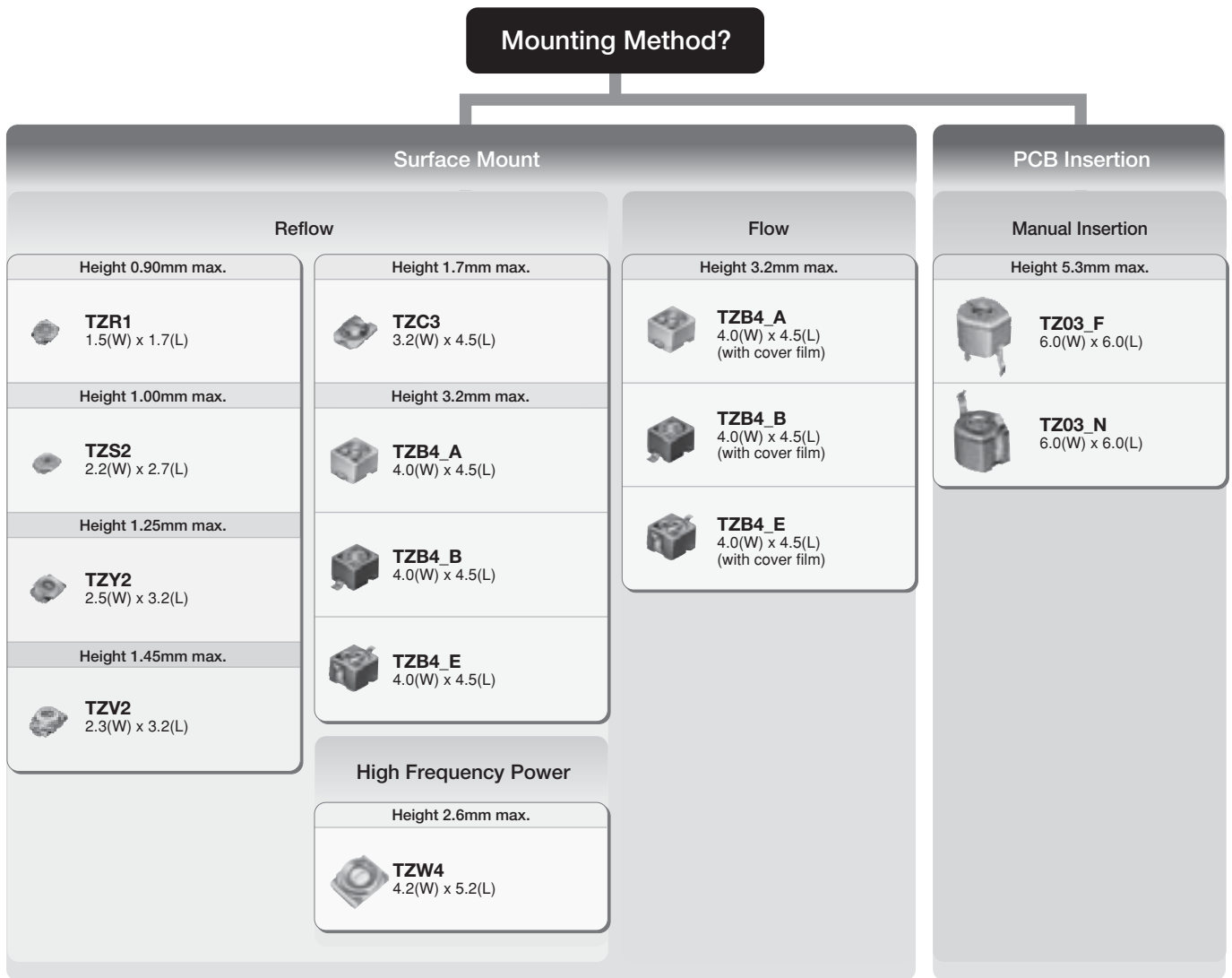
Code	Individual Specifications
001	<b>TZR1, TZS2, TZY2, TZW4</b> Standard Type
110	<b>TZV2, TZC3</b> Standard Type
169	<b>TZ03</b> Standard Type
A10	<b>TZB4</b> No-cover Film Standard Type
B10	<b>TZB4</b> with Cover Film Standard Type

⑦ Packaging

Code	Packaging
B00	Bulk
R00	Reel (Taping ø180mm)
R01*	Reel (Taping ø330mm)

\* TZB4 only.

## Selection Guide of Ceramic Trimmer Capacitors



All Ceramic Trimmer Capacitor products comply with RoHS and ELV.

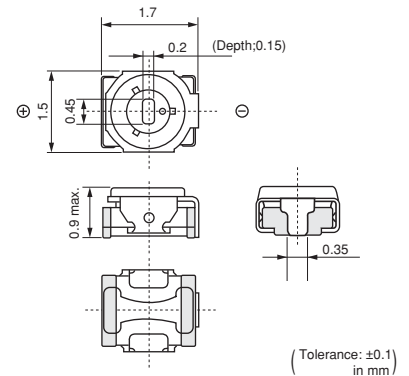
# Ceramic Trimmer Capacitors



## TZR1 Series

### ■ Features

1. Ultra-small and thin with external dimensions of 1.5(W)x1.7(L)x0.85(H)mm (80% less in volume than the current product).
2. Unique construction with no plastic material provides superior soldering heat resistance to maintain excellent characteristic performance after reflow soldering.
3. Suitable for high frequency circuit due to high self-resonant frequency (6.2GHz of TZR1Z010 at 1.0pF setting).



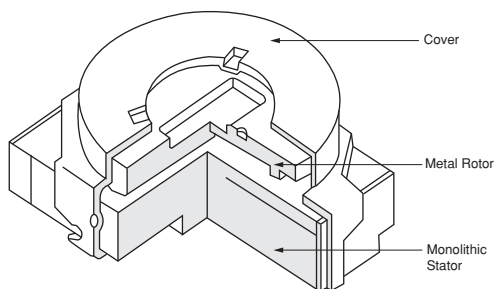
### ■ Applications

1. Bluetooth®
2. Crystal oscillators
3. Crystal filters
4. Hand radios
5. Miniature tuner packs (FM Radio, TV)
6. Remote keyless entry systems
7. Pagers

Part Number	C min. (max.) (pF)	C max. (pF)	TC	Q	Rated Voltage	Withstanding Voltage
TZR1Z010A001	0.55	1.0 +100/-0%	NP0±300ppm/°C	200min. at 200MHz, Cmax.	25Vdc	55Vdc
TZR1Z1R5A001	0.7	1.5 +100/-0%	NP0±300ppm/°C	200min. at 200MHz, Cmax.	25Vdc	55Vdc
TZR1Z040A001	1.5	4.0 +100/-0%	NP0±500ppm/°C	300min. at 1MHz, Cmax.	25Vdc	55Vdc
TZR1R080A001	3.0	8.0 +100/-0%	N750±500ppm/°C	300min. at 1MHz, Cmax.	25Vdc	55Vdc

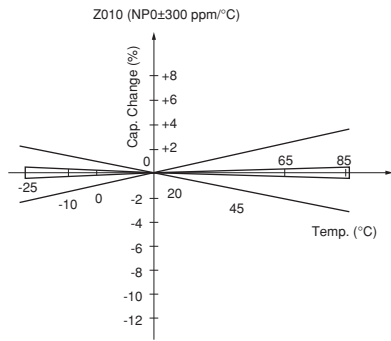
Insulation Resistance: 10000M ohm    Torque: 0.1 to 1.0mNm    Operating Temperature Range: -25 to +85°C

### ■ Construction

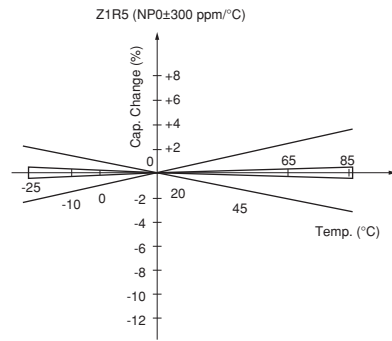


■ Temperature Characteristics

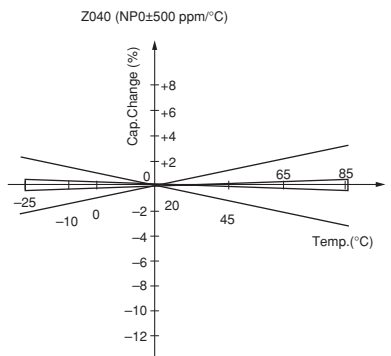
TZR1Z010



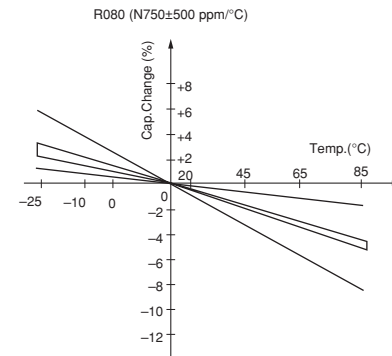
TZR1Z1R5



TZR1Z040

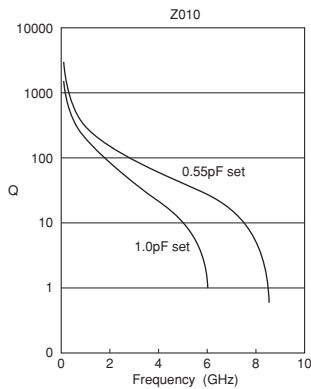


TZR1R080

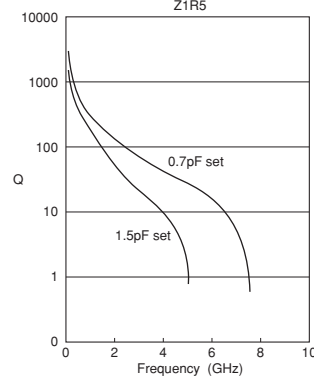


■ Frequency Characteristics

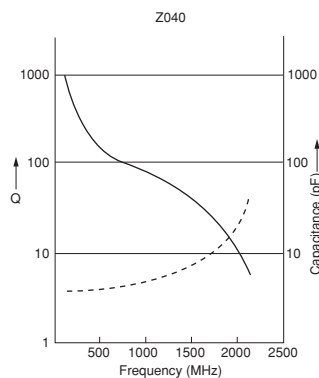
TZR1Z010



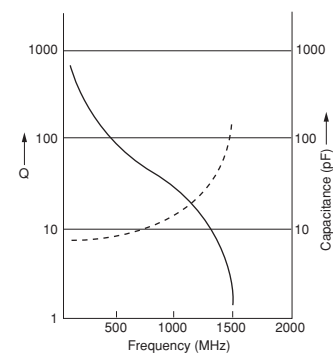
TZR1Z1R5



TZR1Z040

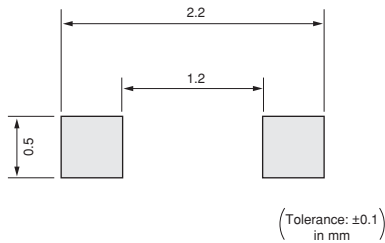


TZR1R080





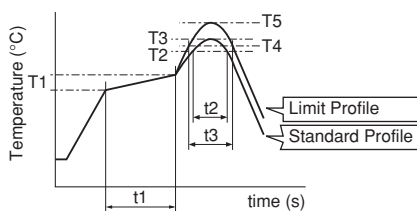
■ Land Pattern



■ Temperature Profile

● Reflow Soldering Profile

① Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu)

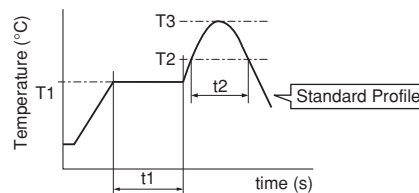


Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150 to 180°C	60 to 120sec.	220°C	30 to 60sec.	245±3°C	2 times

Limit Profile					
Pre-heating		Heating		Peak temperature (T5)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T4)	Time (t3)		
150 to 180°C	60 to 120sec.	230°C	30 to 50sec.	260 +5/-0°C	2 times

② Soldering profile for Eutectic solder (63Sn/37Pb)

(Limit profile: refer to ①)



Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150°C	60 to 120sec.	183°C	30sec.	230 +5/-0°C	1 time

● Soldering Iron

Standard Profile			
Temperature of soldering iron tip	Soldering time	Soldering iron power output	Cycle of soldering iron
350±10°C	3sec. max.	30W max.	1 time

■ Notice (Storage and Operating Conditions)

- Do not use the trimmer capacitor under atmosphere of RTV silicone rubber (Room Temperature Vulcanizing Silicone Rubber) except Acetone liberating silicone sealant.
- Before using trimmer capacitors, please store under the conditions of -10 to +40°C and 30 to 85%RH.
- Do not store in or near corrosive gasses.
- Use within 6 months of delivery.
- Do not store under direct sunlight.
- Do not use the trimmer capacitor under the conditions listed below.
  - Corrosive gasses atmosphere (ex. Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
  - In liquid (ex. water, oil, medical liquid, organic solvent, etc.)
  - Dusty / dirty atmosphere
  - Direct sunlight
  - Static voltage or electric/magnetic fields
  - Direct sea breeze
  - Other variations of the above

## ■ Notice (Soldering and Mounting)

### 1. Soldering

- (1) TZR1 series can be soldered by reflow soldering method and soldering iron. Do not use flow soldering method (dipping).
- (2) Soldering conditions  
Refer to the temperature profile.  
If the soldering conditions are not suitable, e.g., excessive time and/or excessive temperature, the trimmer capacitor may deviate from the specified characteristics.
- (3) The amount of solder is critical.
- (4) The thickness of solder paste should be printed from 100 micro m to 150 micro m and the dimension of land pattern should be Murata's standard land pattern used at reflow soldering.  
Insufficient amounts of solder can lead to insufficient soldering strength on PCB.  
Excessive amounts of solder may cause bridging between the terminals or contact failure due to flux wicking up.
- (5) When using soldering iron, the diameter of the string solder shall be less than 0.5mm. The string solder shall be applied to the lower part of the terminal only. Do not apply flux except to the terminals. Excessive amounts of solder and/or applying solder to the upper part of the terminal may cause fixed metal rotor or contact failure due to flux invasion into the movable part and/or the contact point. The soldering iron should not come in contact with the monolithic stator of the trimmer capacitor. If such contact does occur, the trimmer capacitor may be damaged.

(6) Our recommended chlorine content of solder is as follows.

- (a) Solder paste: 0.2wt% max.
- (b) String solder: 0.5wt% max.

(7) Do not use water-soluble flux (for water cleaning). To prevent the deterioration of trimmer capacitor characteristics, apply flux only to terminals.

### 2. Mounting

- (1) Do not apply excessive force (preferably 5.0 N [Ref: 500gf] max.), when the trimmer capacitor is mounted on the PCB.
- (2) Do not warp and/or bend PCB to protect trimmer capacitor from breaking.
- (3) Use a pick-up nozzle of a suitable dimension. (1.1-1.2mm external diameter and 0.8-0.9mm bore diameter.)

### 3. Cleaning

This product cannot be cleaned because of open construction.

### 4. Other

Note the polarity of the trimmer capacitor to minimize influence by stray capacitance. (Refer to the dimensions concerning the polarity.)

## ■ Notice (Handling)

1. Use suitable screwdrivers that fit comfortably in driver slot.  
\*Recommended screwdriver for manual adjustment  
MURATA: KMDR160
2. When adjusting with a screwdriver, do not apply excessive force (preferably 0.5 N [Ref: 50gf] max.) to minimize capacitance drift. Excessive force applied to the screwdriver slot may cause deformation of the products.

3. Do not apply adhesive, lock paints, or any other substances to the trimmer capacitor to secure the rotor position. They may cause corrosion or electrical contact problems.

## ■ Notice (Other)

Before using trimmer capacitors, please test after assembly in your particular mass production system.

# Ceramic Trimmer Capacitors

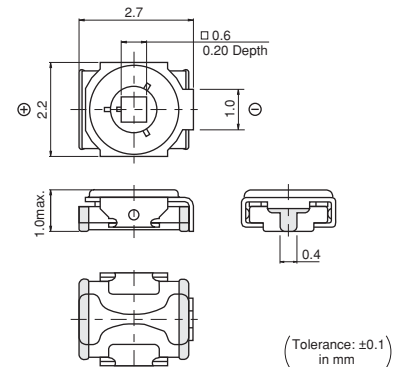


## TZS2 Series

2

### ■ Features

1. Ultra-small and thin type with external dimensions of 2.2(W)x2.7(L)x0.95(H)mm (30% less in volume than the current product).
2. Unique construction with no plastic material provides superior soldering heat resistance to maintain excellent characteristic performance after reflow soldering.
3. Pierced square hole allows for high resistance to tuning force and in-process automatic adjustment.



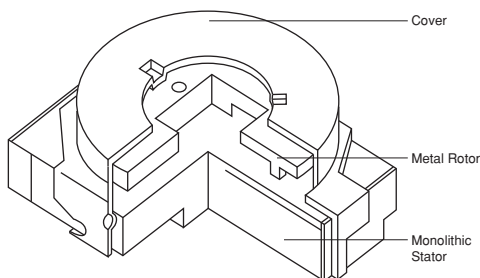
### ■ Applications

1. Crystal oscillators
2. Crystal filters
3. Hand radios
4. Cordless telephones
5. Cellular telephones
6. Tuner packs
7. Pagers
8. Remote keyless entry systems
9. PHS
10. Radar detectors
11. W-LAN
12. Compact radios
13. Headphone stereos

Part Number	C min. (max.) (pF)	C max. (pF)	TC	Q	Rated Voltage	Withstanding Voltage
TZS2Z060A001	3.0	6.0 +100/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZS2Z100A001	3.5	10.0 +100/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZS2R200A001	7.0	20.0 +100/-0%	N750±500ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc

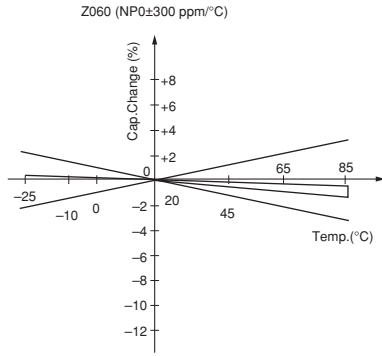
Insulation Resistance: 10000M ohm    Torque: 0.5 to 5.0mNm    Operating Temperature Range: -25 to +85°C

### ■ Construction

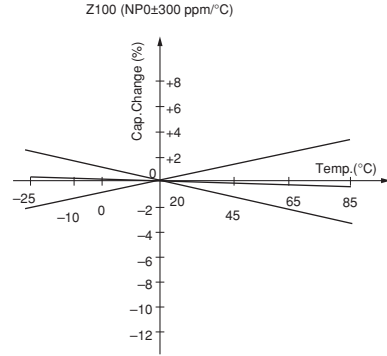


■ Temperature Characteristics

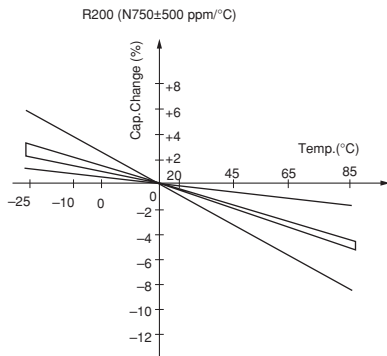
TZS2Z060



TZS2Z100



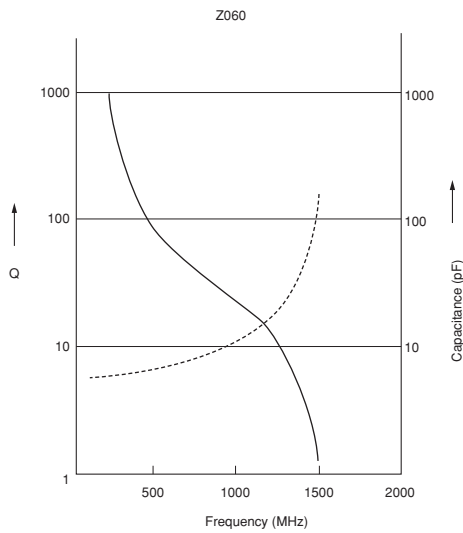
TZS2R200



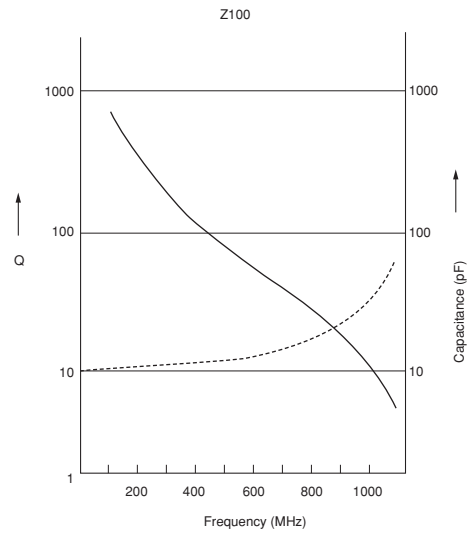
2

■ Frequency Characteristics

TZS2Z060



TZS2Z100

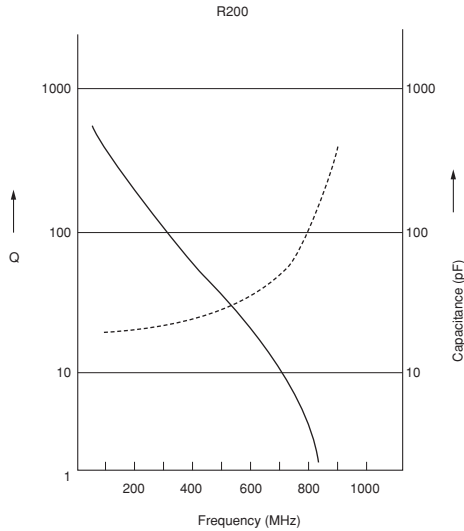


Continued on the following page.

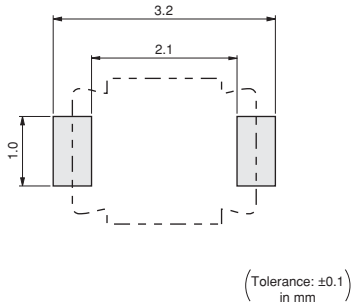
Continued from the preceding page.

## Frequency Characteristics

TZS2R200



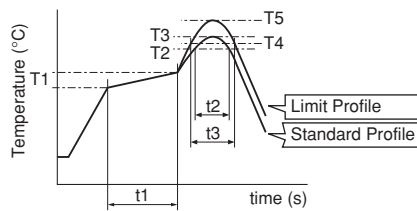
## Land Pattern



## Temperature Profile

### Reflow Soldering Profile

① Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu)

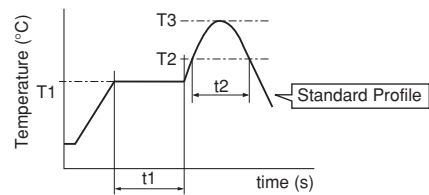


Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150 to 180°C	60 to 120sec.	220°C	30 to 60sec.	245±3°C	2 times

Limit Profile					
Pre-heating		Heating		Peak temperature (T5)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T4)	Time (t3)		
150 to 180°C	60 to 120sec.	230°C	30 to 50sec.	260 +5/-0°C	2 times

② Soldering profile for Eutectic solder (63Sn/37Pb)

(Limit profile: refer to ①)



Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150°C	60 to 120sec.	183°C	30sec.	230 +5/-0°C	1 time

### Soldering Iron

Standard Profile			
Temperature of soldering iron tip	Soldering time	Soldering iron power output	Cycle of soldering iron
350±10°C	3sec. max.	30W max.	1 time

### ■ Notice (Storage and Operating Conditions)

1. Do not use the trimmer capacitor under atmosphere of RTV silicone rubber (Room Temperature Vulcanizing Silicone Rubber) except Acetone liberating silicone sealant.
2. Before using trimmer capacitors, please store under the conditions of -10 to +40°C and 30 to 85%RH.
3. Do not store in or near corrosive gasses.
4. Use within 6 months of delivery.
5. Do not store under direct sunlight.

### ■ Notice (Soldering and Mounting)

1. Soldering
  - (1) TZS2 series can be soldered by reflow soldering method and soldering iron. Do not use flow soldering method (dipping).
  - (2) Soldering conditions  
Refer to the temperature profile.  
If the soldering conditions are not suitable, e.g., excessive time and/or excessive temperature, the trimmer capacitor may deviate from the specified characteristics.
  - (3) The amount of solder is critical.
  - (4) The thickness of solder paste should be printed from 100 micro m to 150 micro m and the dimension of land pattern should be Murata's standard land pattern used at reflow soldering.  
Insufficient amounts of solder can lead to insufficient soldering strength on PCB.  
Excessive amounts of solder may cause bridging between the terminals or contact failure due to flux wicking up.
  - (5) When using soldering iron, the diameter of the string solder shall be less than 0.5mm. The string solder shall be applied to the lower part of the terminal only. Do not apply flux except to the terminals. Excessive amounts of solder and/or applying solder to the upper part of the terminal may cause fixed metal rotor or contact failure due to flux invasion into the movable

### ■ Notice (Handling)

1. Use suitable screwdrivers that fit comfortably in driver slot.
  - (1) Recommended screwdriver for manual adjustment  
MURATA: KMDR050
  - (2) Recommended screwdriver bit for automatic adjustment  
MURATA: KMBT050

### ■ Notice (Other)

Before using trimmer capacitors, please test after assembly in your particular mass production system.

6. Do not use the trimmer capacitor under the conditions listed below.
  - (1) Corrosive gasses atmosphere  
(ex. Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
  - (2) In liquid (ex. water, oil, medical liquid, organic solvent, etc.)
  - (3) Dusty / dirty atmosphere
  - (4) Direct sunlight
  - (5) Static voltage or electric/magnetic fields
  - (6) Direct sea breeze
  - (7) Other variations of the above

part and/or the contact point. The soldering iron should not come in contact with the monolithic stator of the trimmer capacitor. If such contact does occur, the trimmer capacitor may be damaged.

- (6) Our recommended chlorine content of solder is as follows.
    - (a) Solder paste: 0.2wt% max.
    - (b) String solder: 0.5wt% max.
  - (7) Do not use water-soluble flux (for water cleaning). To prevent the deterioration of trimmer capacitor characteristics, apply flux only to terminals.
2. Mounting
    - (1) Do not apply excessive force (preferably 5.0 N [Ref: 500gf] max.), when the trimmer capacitor is mounted on the PCB.
    - (2) Do not warp and/or bend PCB to protect trimmer capacitor from breakage.
    - (3) Use a pick-up nozzle of a suitable dimension.  
(1.8mm external diameter and 1.3mm bore diameter.)
  3. Cleaning  
This product cannot be cleaned because of open construction.
  4. Other  
Note the polarity of the trimmer capacitor to minimize influence by stray capacitance.  
(Refer to the dimensions concerning the polarity.)

2. When adjusting with a screwdriver, do not apply excessive force (preferably 1.0 N [Ref: 100gf] max.) to minimize capacitance drift. Excessive force applied to the screwdriver slot may cause deformation of the products.
3. Do not apply adhesive, lock paints, or any other substances to the trimmer capacitor to secure the rotor position. They may cause corrosion or electrical contact problems.



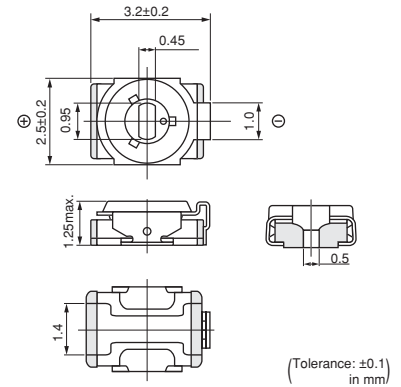
# Ceramic Trimmer Capacitors



## TZY2 Series

### ■ Features

1. Small and thin size with external dimensions of 2.5(W)x3.2(L)x1.25max.(H)mm.
2. New shape of cover can improve the flux invasion compared with current products.
3. Improvement of the adhesion between rotor and stator leads to superior stability.
4. Unique construction with no plastic material provides superior soldering heat resistance to maintain excellent characteristic performance after reflow soldering.
5. Suitable for high frequency circuit due to high self-resonant frequency (4.8GHz of TZY2Z010 at 1.0pF setting).



3

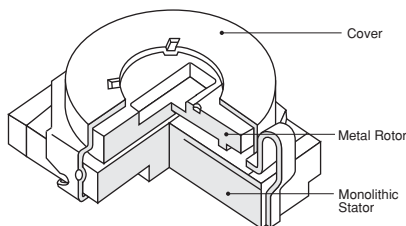
### ■ Applications

- |                        |                                 |
|------------------------|---------------------------------|
| 1. Crystal oscillators | 9. Remote keyless entry systems |
| 2. Crystal filters     | 10. W-LAN                       |
| 3. Pagers              | 11. Radar detectors             |
| 4. Cordless telephones | 12. Compact radios              |
| 5. PHS                 | 13. DVD                         |
| 6. Hand radios         | 14. Burglarproof devices        |
| 7. Cellular telephones | 15. Headphone stereos           |
| 8. Watches             |                                 |

Part Number	C min. (max.) (pF)	C max. (pF)	TC	Q	Rated Voltage	Withstanding Voltage
TZY2Z010A001	0.5	1.0 +100/-0%	NP0±300ppm/°C	200min. at 200MHz, Cmax.	25Vdc	55Vdc
TZY2Z2R5A001	0.65	2.5 +100/-0%	NP0±300ppm/°C	200min. at 200MHz, Cmax.	25Vdc	55Vdc
TZY2Z030A001	1.5	3.0 +100/-0%	NP0±300ppm/°C	300min. at 1MHz, Cmax.	25Vdc	55Vdc
TZY2Z060A001	2.5	6.0 +100/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZY2Z100A001	3.0	10.0 +100/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZY2R200A001	4.5	20.0 +100/-0%	N750±500ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZY2R250A001	5.5	25.0 +100/-0%	N750±500ppm/°C	300min. at 1MHz, Cmax.	25Vdc	55Vdc
TZY2K450A001	8.0	45.0 +100/-0%	N1000±500ppm/°C	300min. at 1MHz, Cmax.	25Vdc	55Vdc

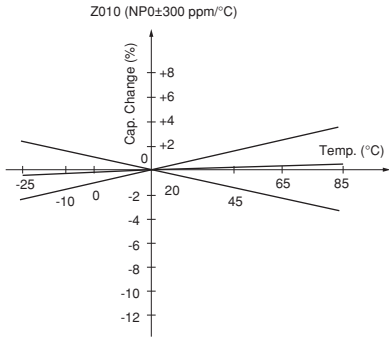
Insulation Resistance: 10000M ohm    Torque: 0.5 to 5.0mNm    Operating Temperature Range: -25 to +85°C

### ■ Construction

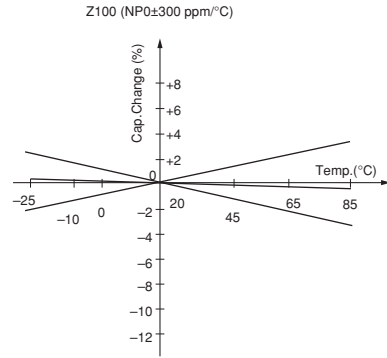


■ Temperature Characteristics

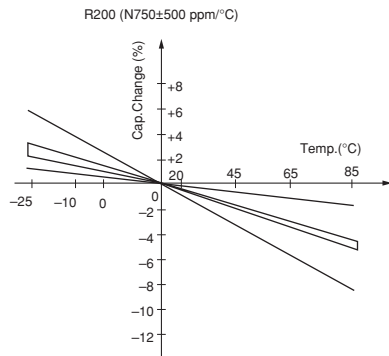
TZY2Z010



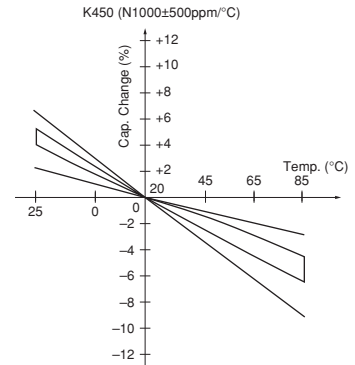
TZY2Z100



TZY2R200



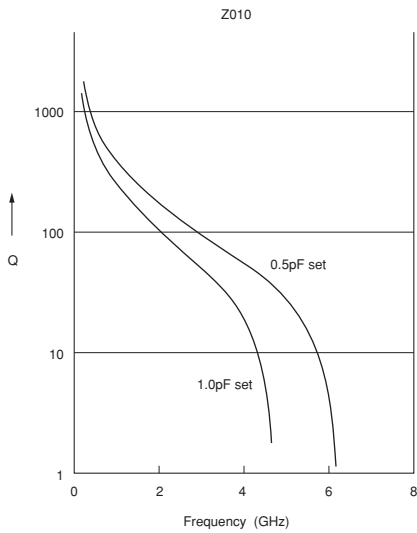
TZY2K450



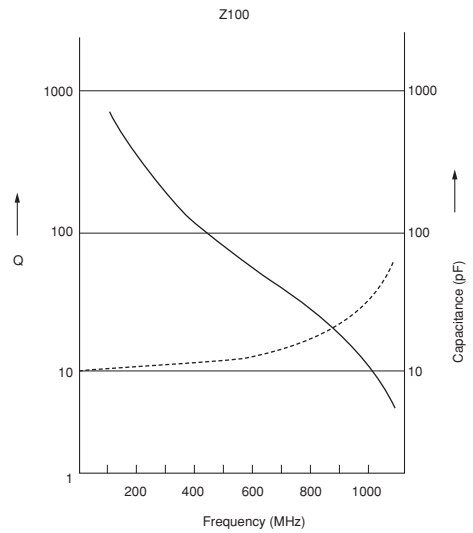
3

■ Frequency Characteristics

TZY2Z010



TZY2Z100

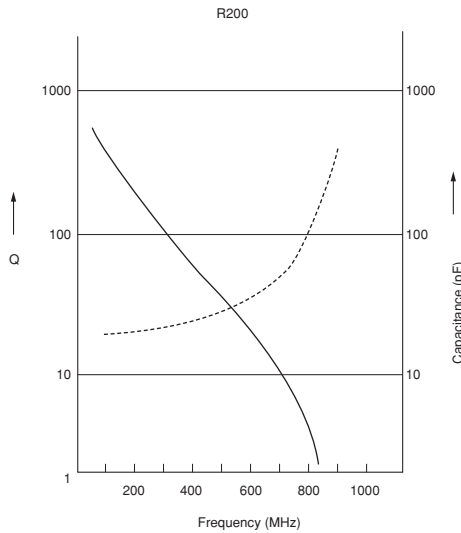


Continued on the following page.

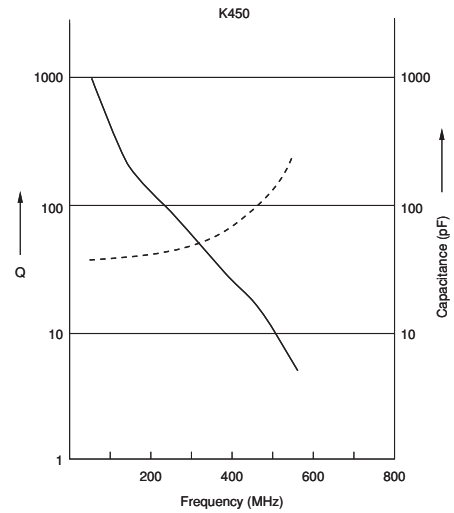
Continued from the preceding page.

### Frequency Characteristics

TZY2R200

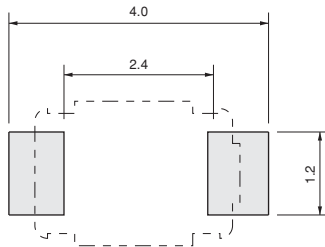


TZY2K450



3

### Land Pattern

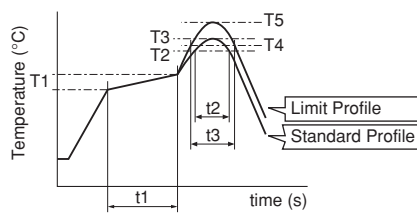


(Tolerance: ±0.1 in mm)

### Temperature Profile

#### Reflow Soldering Profile

① Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu)

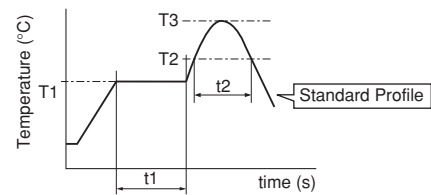


Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150 to 180°C	60 to 120sec.	220°C	30 to 60sec.	245±3°C	2 times

Limit Profile					
Pre-heating		Heating		Peak temperature (T5)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T4)	Time (t3)		
150 to 180°C	60 to 120sec.	230°C	30 to 50sec.	260 +5/-0°C	2 times

② Soldering profile for Eutectic solder (63Sn/37Pb)

(Limit profile: refer to ①)



Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150°C	60 to 120sec.	183°C	30sec.	230 +5/-0°C	1 time

### Soldering Iron

Standard Profile			
Temperature of soldering iron tip	Soldering time	Soldering iron power output	Cycle of soldering iron
350±10°C	3sec. max.	30W max.	1 time

### ■ Notice (Storage and Operating Conditions)

1. Do not use the trimmer capacitor under atmosphere of RTV silicone rubber (Room Temperature Vulcanizing Silicone Rubber) except Acetone liberating silicone sealant.
2. Before using trimmer capacitors, please store under the conditions of -10 to +40°C and 30 to 85%RH.
3. Do not store in or near corrosive gasses.
4. Use within 6 months of delivery.
5. Do not store under direct sunlight.

### ■ Notice (Soldering and Mounting)

1. Soldering
  - (1) TZY2 series can be soldered by reflow soldering method and soldering iron. Do not use flow soldering method (dipping).
  - (2) Soldering conditions  
Refer to the temperature profile.  
If the soldering conditions are not suitable, e.g., excessive time and/or excessive temperature, the trimmer capacitor may deviate from the specified characteristics.
  - (3) The amount of solder is critical.
  - (4) The thickness of solder paste should be printed from 120 micro m to 170 micro m and the dimension of land pattern should be Murata's standard land pattern used at reflow soldering.  
Insufficient amounts of solder can lead to insufficient soldering strength on PCB.  
Excessive amounts of solder may cause bridging between the terminals or contact failure due to flux wicking up.
  - (5) When using soldering iron, the diameter of the string solder shall be less than 0.5mm. The string solder shall be applied to the lower part of the terminal only. Do not apply flux except to the terminals. Excessive amounts of solder and/or applying solder to the upper part of the terminal may cause fixed metal rotor or contact failure due to flux invasion into

### ■ Notice (Handling)

1. Use suitable screwdrivers that fit comfortably in driver slot.
  - (1) Recommended screwdriver for manual adjustment  
ENGINEER INC.: DA-89  
(Murata P/N is KMDR060)
  - (2) Recommended screwdriver bit for automatic adjustment  
MURATA: KMBT060

### ■ Notice (Other)

Before using trimmer capacitors, please test after assembly in your particular mass production system.

6. Do not use the trimmer capacitor under the conditions listed below.
  - (1) Corrosive gasses atmosphere  
(ex. Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
  - (2) In liquid (ex. water, oil, medical liquid, organic solvent, etc.)
  - (3) Dusty / dirty atmosphere
  - (4) Direct sunlight
  - (5) Static voltage or electric/magnetic fields
  - (6) Direct sea breeze
  - (7) Other variations of the above

the movable part and/or the contact point. The soldering iron should not come in contact with the monolithic stator of the trimmer capacitor. If such contact does occur, the trimmer capacitor may be damaged.

- (6) Our recommended chlorine content of solder is as follows.
    - (a) Solder paste: 0.2wt% max.
    - (b) String solder: 0.5wt% max.
  - (7) Do not use water-soluble flux (for water cleaning). To prevent the deterioration of trimmer capacitor characteristics, apply flux only to terminals.
2. Mounting
    - (1) Do not apply excessive force (preferably 5.0 N [Ref: 500gf] max.), when the trimmer capacitor is mounted on the PCB.
    - (2) Do not warp and/or bend PCB to protect trimmer capacitor from breakage.
    - (3) Use a pick-up nozzle of a suitable dimension.  
(1.8mm external diameter and 1.3mm bore diameter.)
  3. Cleaning  
This product cannot be cleaned because of open construction.
  4. Other  
Note the polarity of the trimmer capacitor to minimize influence by stray capacitance.  
(Refer to the dimensions concerning the polarity.)

2. When adjusting with a screwdriver, do not apply excessive force (preferably 1.0 N [Ref: 100gf] max.) to minimize capacitance drift. Excessive force applied to the screwdriver slot may cause deformation of the products.
3. Do not apply adhesive, lock paints, or any other substances to the trimmer capacitor to secure the rotor position. They may cause corrosion or electrical contact problems.

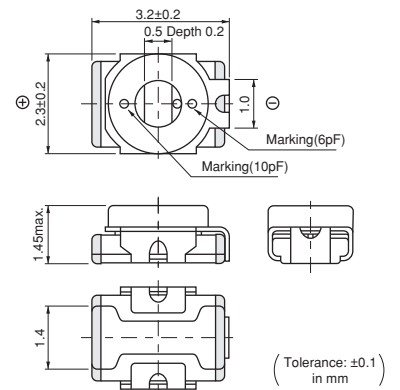
# Ceramic Trimmer Capacitors



## TZV2 Series

### ■ Features

1. Small size with external dimensions of 2.3(W)x3.2(L)x1.45max.(H)mm.
2. Unique construction with no plastic material provides superior soldering heat resistance to maintain excellent characteristic performance after reflow soldering.
3. Designed for automatic placement in surface mount applications.
4. Funnel shaped metal case enables in-process automatic adjustment.



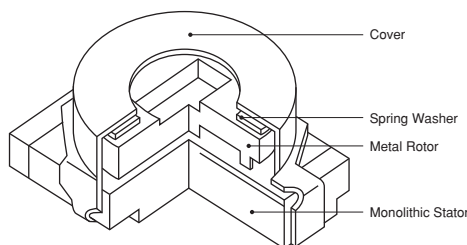
### ■ Applications

1. Crystal oscillator
2. Crystal filters
3. Hand radios
4. Cordless telephones
5. Cellular telephones
6. Tuner packs
7. Pagers
8. Remote keyless entry systems
9. PHS
10. Radar detectors
11. W-LAN
12. Compact radios
13. Headphone stereos
14. DVD
15. Burglarproof devices

Part Number	C min. (max.) (pF)	C max. (pF)	TC	Q	Rated Voltage	Withstanding Voltage
TZV2Z2R5A110	0.65	2.5 +100/-0%	NP0±300ppm/°C	200min. at 200MHz, Cmax.	25Vdc	55Vdc
TZV2Z030A110	1.5	3.0 +100/-0%	NP0±300ppm/°C	300min. at 1MHz, Cmax.	25Vdc	55Vdc
TZV2Z060A110	2.5	6.0 +100/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZV2Z100A110	3.0	10.0 +100/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc
TZV2R200A110	4.5	20.0 +100/-0%	N750±500ppm/°C	500min. at 1MHz, Cmax.	25Vdc	55Vdc

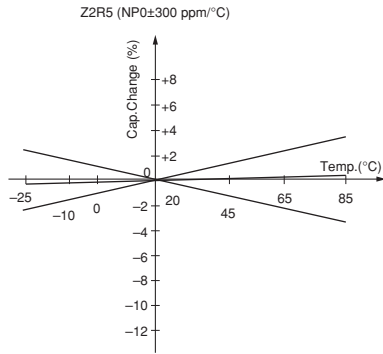
Insulation Resistance: 10000M ohm    Torque: 1.0 to 9.8mNm    Operating Temperature Range: -25 to +85°C

### ■ Construction

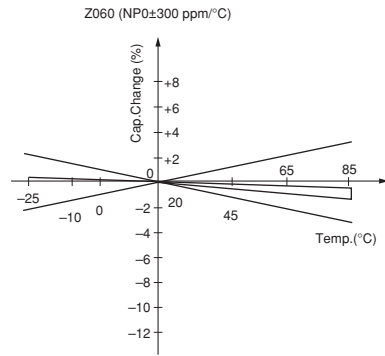


## Temperature Characteristics

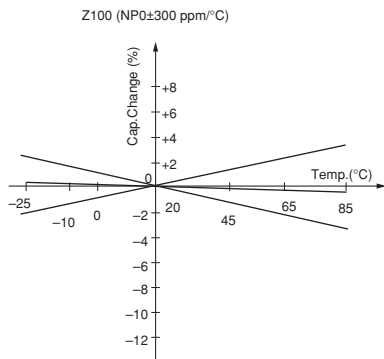
**TZV2Z2R5**



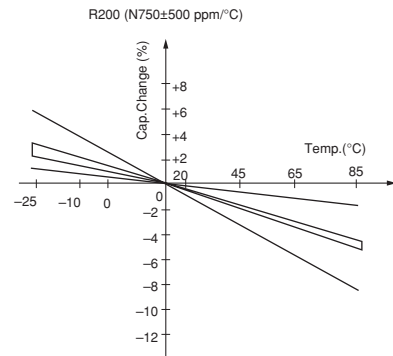
**TZV2Z060**



**TZV2Z100**



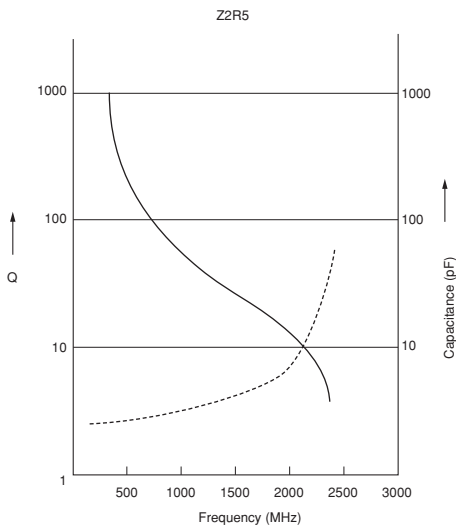
**TZV2R200**



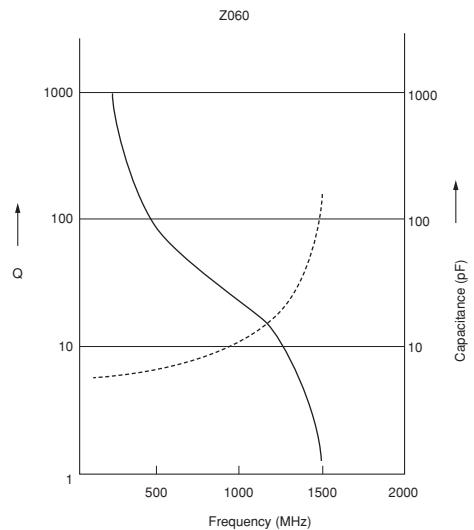
4

## Frequency Characteristics

**TZV2Z2R5**



**TZV2Z060**

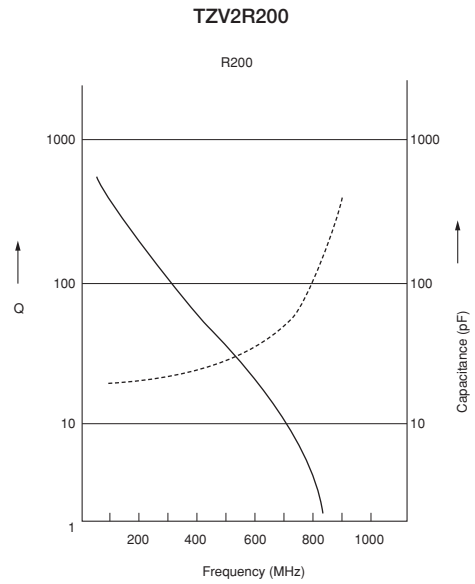
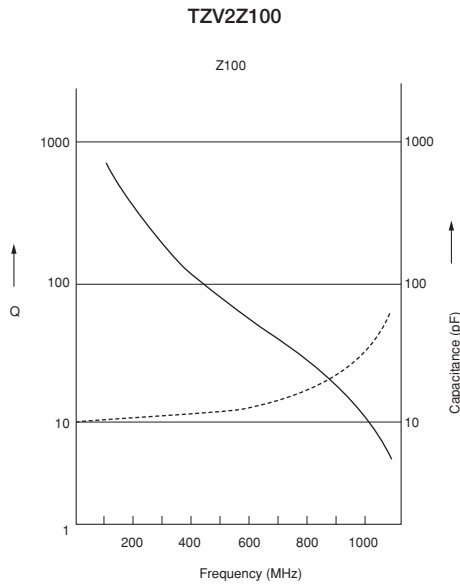


Continued on the following page.



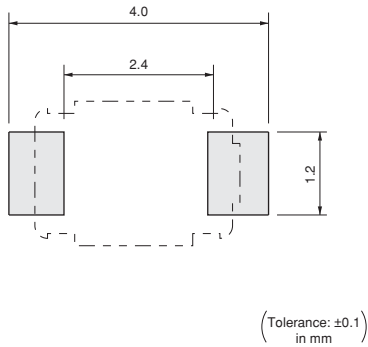
Continued from the preceding page.

## Frequency Characteristics



4

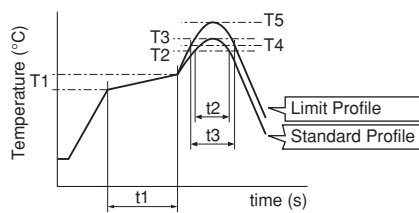
## Land Pattern



## Temperature Profile

### Reflow Soldering Profile

① Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu)

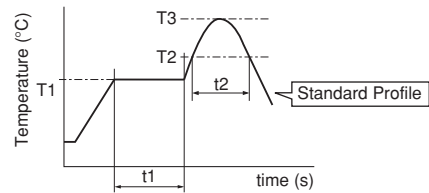


Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150 to 180°C	60 to 120sec.	220°C	30 to 60sec.	245±3°C	2 times

Limit Profile					
Pre-heating		Heating		Peak temperature (T5)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T4)	Time (t3)		
150 to 180°C	60 to 120sec.	230°C	30 to 50sec.	260 +5/-0°C	2 times

② Soldering profile for Eutectic solder (63Sn/37Pb)

(Limit profile: refer to ①)



Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150°C	60 to 120sec.	183°C	30sec.	230 +5/-0°C	1 time

### Soldering Iron

Standard Profile			
Temperature of soldering iron tip	Soldering time	Soldering iron power output	Cycle of soldering iron
350±10°C	3sec. max.	30W max.	1 time

### ■ Notice (Storage and Operating Conditions)

1. Do not use the trimmer capacitor under atmosphere of RTV silicone rubber (Room Temperature Vulcanizing Silicone Rubber) except Acetone liberating silicone sealant.
2. Before using trimmer capacitors, please store under the conditions of -10 to +40°C and 30 to 85%RH.
3. Do not store in or near corrosive gasses.
4. Use within 6 months of delivery.
5. Do not store under direct sunlight.

### ■ Notice (Soldering and Mounting)

1. Soldering
  - (1) TZV2 series can be soldered by reflow soldering method and soldering iron. Do not use flow soldering method (dipping).
  - (2) Soldering conditions  
Refer to the temperature profile.  
If the soldering conditions are not suitable, e.g., excessive time and/or excessive temperature, the trimmer capacitor may deviate from the specified characteristics.
  - (3) The amount of solder is critical.
  - (4) The thickness of solder paste should be printed from 120 micro m to 170 micro m and the dimension of land pattern should be Murata's standard land pattern used at reflow soldering.  
Insufficient amounts of solder can lead to insufficient soldering strength on PCB.  
Excessive amounts of solder may cause bridging between the terminals or contact failure due to flux wicking up.
  - (5) When using soldering iron, the diameter of the string solder shall be less than 0.5mm. The string solder shall be applied to the lower part of the terminal only. Do not apply flux except to the terminals. Excessive amounts of solder and/or applying solder to the upper part of the terminal may cause fixed metal rotor or contact failure due to flux invasion into

### ■ Notice (Handling)

1. Use suitable screwdrivers that fit comfortably in driver slot.
  - (1) Recommended screwdriver for manual adjustment  
VESSEL: No.9000 -0.9x30  
(Murata P/N : KMDR020)
  - (2) Recommended screwdriver bit for automatic adjustment  
MURATA: KMBT020

### ■ Notice (Other)

Before using trimmer capacitors, please test after assembly in your particular mass production system.

6. Do not use the trimmer capacitor under the conditions listed below.
  - (1) Corrosive gasses atmosphere  
(ex. Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
  - (2) In liquid (ex. water, oil, medical liquid, organic solvent, etc.)
  - (3) Dusty / dirty atmosphere
  - (4) Direct sunlight
  - (5) Static voltage or electric/magnetic fields
  - (6) Direct sea breeze
  - (7) Other variations of the above

the movable part and/or the contact point. The soldering iron should not come in contact with the monolithic stator of the trimmer capacitor. If such contact does occur, the trimmer capacitor may be damaged.

- (6) Our recommended chlorine content of solder is as follows.
    - (a) Solder paste: 0.2wt% max.
    - (b) String solder: 0.5wt% max.
  - (7) Do not use water-soluble flux (for water cleaning). To prevent the deterioration of trimmer capacitor characteristics, apply flux only to terminals.
2. Mounting
    - (1) Do not apply excessive force (preferably 5.0 N [Ref: 500gf] max.), when the trimmer capacitor is mounted on the PCB.
    - (2) Do not warp and/or bend PCB to protect trimmer capacitor from breakage.
    - (3) Use a pick-up nozzle of a suitable dimension.  
(1.8mm external diameter and 1.3mm bore diameter.)
  3. Cleaning  
This product cannot be cleaned because of open construction.
  4. Other  
Note the polarity of the trimmer capacitor to minimize influence by stray capacitance.  
(Refer to the dimensions concerning the polarity.)

2. When adjusting with a screwdriver, do not apply excessive force (preferably 1.0 N [Ref: 100gf] max.) to minimize capacitance drift. Excessive force applied to the screwdriver slot may cause deformation of the products.
3. Do not apply adhesive, lock paints, or any other substances to the trimmer capacitor to secure the rotor position. They may cause corrosion or electrical contact problems.

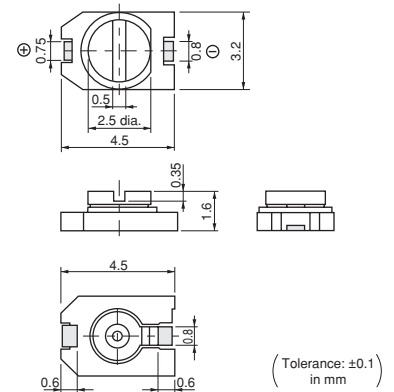
# Ceramic Trimmer Capacitors



## TZC3 Series

### ■ Features

1. Small size with external dimension of 3.2(W)x4.5(L)x1.6(H)mm.
2. Color coded stator permits easy identification of capacitance and reduces mounting errors.
3. Can be adjusted with conventional adjustment tools having a thickness of 0.5mm.
4. Designed for automatic placement in surface mount applications.
5. Heat resistant resin withstands reflow soldering temperatures.



### ■ Applications

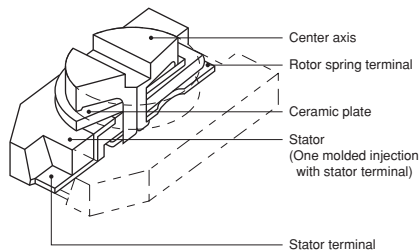
1. Compact radios
2. Headphones
3. Pagers
4. Portable radio equipment
5. Hybrid ICs
6. Cellular telephones
7. Cordless telephones
8. Remote keyless entry systems

5

Part Number	C min. (max.) (pF)	C max. (pF)	TC	Q	Rated Voltage	Withstanding Voltage	Stator/Case Color
TZC3Z030A110	1.4	3.0 +50/-0%	NP0±300ppm/°C	300min. at 1MHz, Cmax.	100Vdc	220Vdc	Brown
TZC3Z060A110	2.0	6.0 +50/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	100Vdc	220Vdc	Blue
TZC3R100A110	3.0	10.0 +50/-0%	N750±300ppm/°C	500min. at 1MHz, Cmax.	100Vdc	220Vdc	White
TZC3P200A110	5.0	20.0 +50/-0%	N1200±500ppm/°C	300min. at 1MHz, Cmax.	100Vdc	220Vdc	Red
TZC3P300A110	6.5	30.0 +50/-0%	N1200±500ppm/°C	300min. at 1MHz, Cmax.	100Vdc	220Vdc	Green

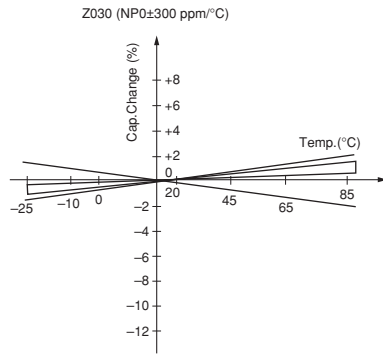
Insulation Resistance: 10000M ohm    Torque: 1.5 to 9.8mNm    Operating Temperature Range: -25 to +85°C

### ■ Construction

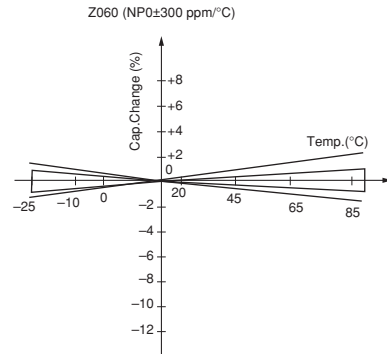


## Temperature Characteristics

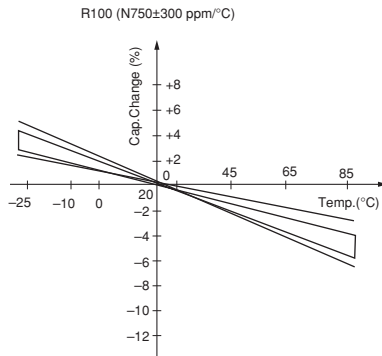
**TZC3Z030**



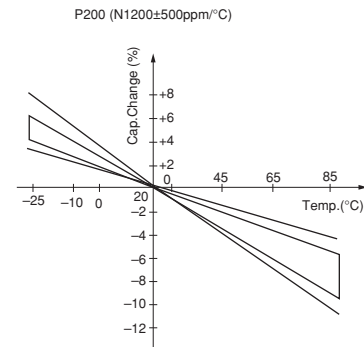
**TZC3Z060**



**TZC3R100**



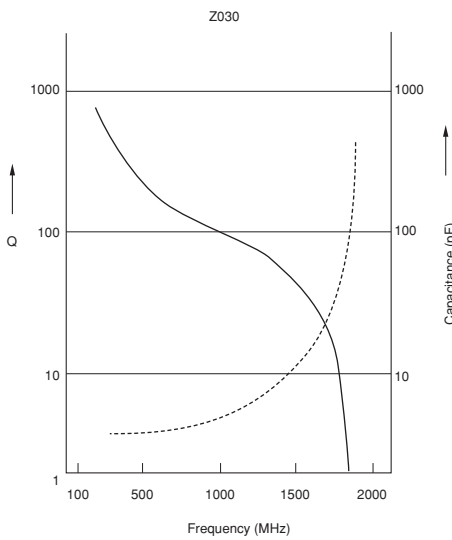
**TZC3P200**



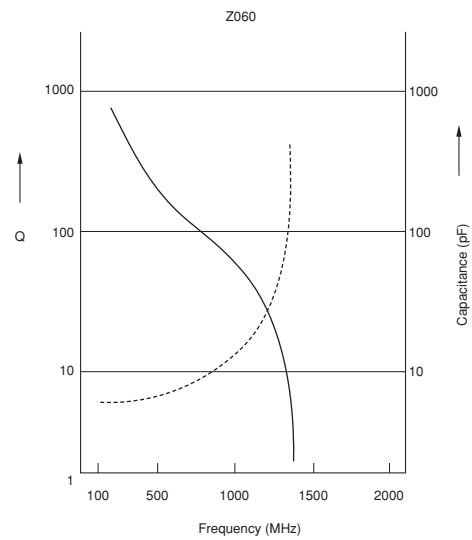
5

## Frequency Characteristics

**TZC3Z030**



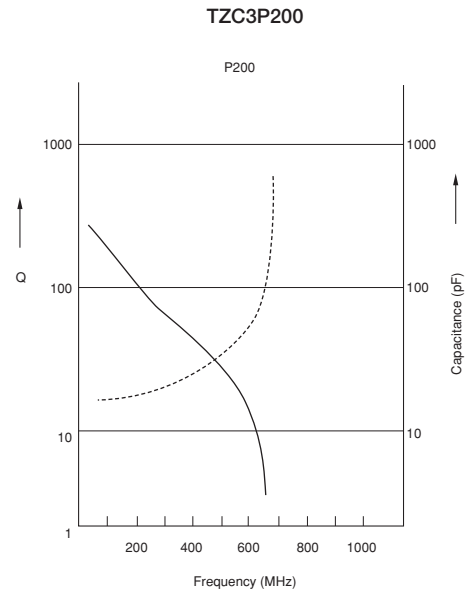
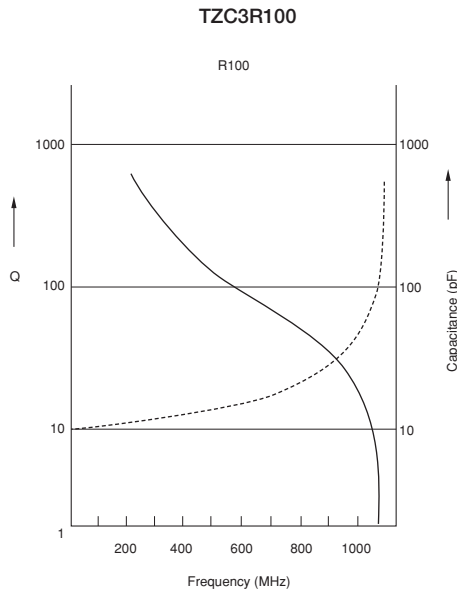
**TZC3Z060**



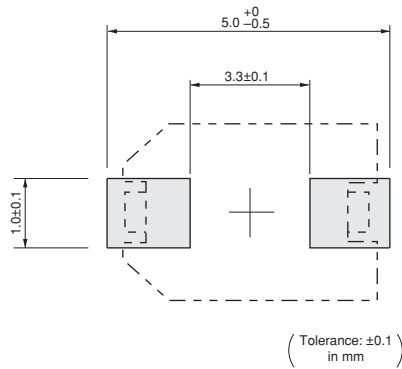
Continued on the following page.

Continued from the preceding page.

## Frequency Characteristics



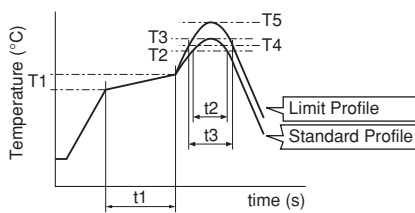
## Land Pattern



## Temperature Profile

### Reflow Soldering Profile

① Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu)

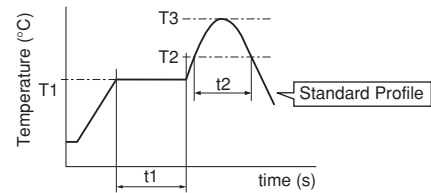


Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150 to 180°C	60 to 120sec.	220°C	30 to 60sec.	245±3°C	2 times

Limit Profile					
Pre-heating		Heating		Peak temperature (T5)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T4)	Time (t3)		
150 to 180°C	60 to 120sec.	230°C	30 to 50sec.	260 +5/-0°C	2 times

② Soldering profile for Eutectic solder (63Sn/37Pb)

(Limit profile: refer to ①)



Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150°C	60 to 120sec.	183°C	30sec.	230 +5/-0°C	1 time

### Soldering Iron

Standard Profile			
Temperature of soldering iron tip	Soldering time	Soldering iron power output	Cycle of soldering iron
350±10°C	3sec. max.	30W max.	1 time

5

### ■ Notice (Storage and Operating Conditions)

1. Do not use the trimmer capacitor under atmosphere of RTV silicone rubber (Room Temperature Vulcanizing Silicone Rubber) except Acetone liberating silicone sealant.
2. Before using trimmer capacitors, please store under the conditions of -10 to +40°C and 30 to 85%RH.
3. Do not store in or near corrosive gasses.
4. Use within 6 months of delivery.
5. Do not store under direct sunlight.

### ■ Notice (Soldering and Mounting)

#### 1. Soldering

- (1) TZC3 series can be soldered by reflow soldering method and soldering iron. Do not use flow soldering method (dipping).
- (2) Soldering conditions  
Refer to the temperature profile.  
If the soldering conditions are not suitable, e.g., excessive time and/or excessive temperature, the trimmer capacitor may deviate from the specified characteristics.
- (3) The amount of solder is critical.
- (4) The thickness of solder paste should be printed from 150 micro m to 200 micro m and the dimension of land pattern should be Murata's standard land pattern used at reflow soldering.  
Insufficient amounts of solder can lead to insufficient soldering strength on PCB.  
Excessive amounts of solder may cause bridging between the terminals or contact failure due to flux wicking up.
- (5) When using soldering iron, the diameter of the string solder shall be less than 0.5mm. The string solder shall be applied to the lower part of the terminal only. Do not apply flux except to the terminals. Excessive amounts of solder and/or applying solder to the upper part of the terminal may cause fixed metal rotor or contact failure due to flux invasion into the movable part and/or the contact point. The

#### ■ Notice (Handling)

1. Use suitable screwdrivers that fit comfortably in driver slot.
  - (1) Recommended screwdriver for manual adjustment  
Standard type --> MURATA: KMDR010  
Cross slot type --> VESSEL: NO.9000+1.7×30  
(Murata P/N is KMDR080)
  - (2) Recommended screwdriver bit for automatic adjustment  
Standard type --> MURATA: KMBT010  
Cross slot type --> VESSEL: No.CA-11  
(Murata P/N is KMBT080)

#### ■ Notice (Other)

Before using trimmer capacitors, please test after assembly in your particular mass production system.

6. Do not use the trimmer capacitor under the conditions listed below.
  - (1) Corrosive gasses atmosphere  
(ex. Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
  - (2) In liquid (ex. water, oil, medical liquid, organic solvent, etc.)
  - (3) Dusty / dirty atmosphere
  - (4) Direct sunlight
  - (5) Static voltage or electric/magnetic fields
  - (6) Direct sea breeze
  - (7) Other variations of the above

soldering iron should not come in contact with the stator of the trimmer capacitor. If such contact does occur, the trimmer capacitor may be damaged.

- (6) Our recommended chlorine content of solder is as follows.
  - (a) Solder paste: 0.2wt% max.
  - (b) String solder: 0.5wt% max.
- (7) Do not use water-soluble flux (for water cleaning).  
To prevent the deterioration of trimmer capacitor characteristics, apply flux only to terminals.
- (8) When soldering the TZC3 series, the solder should not flow into the staking part of the substrate. If such flow does occur, driver slot rotation will be damaged.

#### 2. Mounting

- (1) Do not apply excessive force (preferably 5.0 N [Ref: 500gf] max.), when the trimmer capacitor is mounted on the PCB.
- (2) Do not warp and/or bend PCB to protect trimmer capacitor from breakage.
- (3) Use a pick-up nozzle of a suitable dimension.  
(2.5mm external diameter and 1.5mm bore diameter.)

#### 3. Cleaning

This product cannot be cleaned because of open construction.

#### 4. Other

Note the polarity of the trimmer capacitor to minimize influence by stray capacitance.  
(Refer to the dimensions concerning the polarity.)

2. When adjusting with a screwdriver, do not apply excessive force (preferably 1.0 N [Ref: 100gf] max.) to minimize capacitance drift. Excessive force applied to the screwdriver slot may cause deformation of the products.
3. Do not apply adhesive, lock paints, or any other substances to the trimmer capacitor to secure the rotor position. They may cause corrosion or electrical contact problems.